

# Tooling with modules for ATLAS ITk strip upgrade

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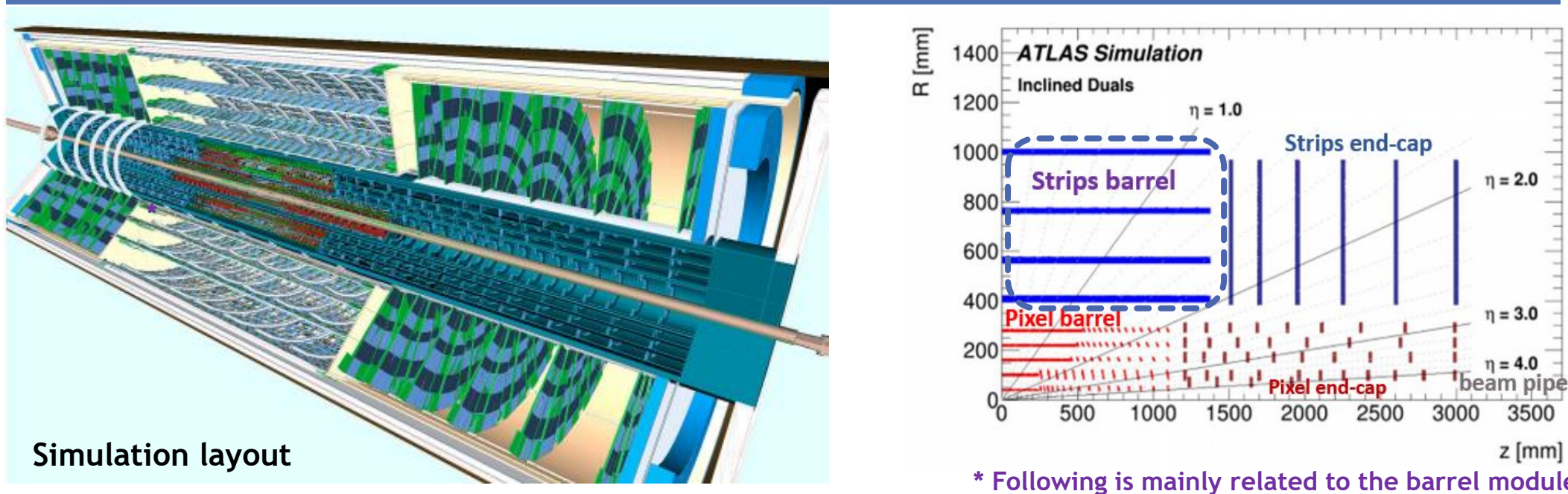
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## Introduction & Motivation

- ◆ The ATLAS experiment is planning a complete replacement of its inner detector(ID) with a new all-silicon inner tracker(ITk) for the HL-LHC
- ◆ The ITk is designed to cope with the increased pile-up, data rates and radiation levels, maintaining or improving the tracking performance
- ◆ The ITk design and technology R&D have been completed and pre-production of the detector modules is starting
- ◆ This work presents the ITk layout, tooling with modules for ATLAS ITk strip upgrade

### ITk layout



### Experimental environment



- ◆ ISO Class 7(Clean room)
- ◆ Temperature:  $\sim 20^{\circ}\text{C}$
- ◆ Humidity:  $\sim 45\%$
- ◆ Equipment: OGP

## Module production & Metrology results

#### Reception Test

Hybrid PCB, ASICs, Sensor, Power Board

Gluing, Wire Bonding, Electrical Tests, Burn-in, Hybrid, Thermal Cycling, Module, Package Shipment

#### Gluing

#### Ship chips

#### UV curing

#### assembled

#### Visual inspection

#### Metrology requirement for Hybrid

Average Glue Height per ASIC:  $120 \pm 40 \mu\text{m}$

Average Package Height per ASIC:  $800 \pm 40 \mu\text{m}$

ASIC position:  $\pm 200 \mu\text{m}$

ASIC flatness:  $\pm 0.025$

#### Metrology requirement for Module

Module metrology result: within  $-10/+10 \mu\text{m}$

Bow test result:  $\pm 0.25 \text{mm}$

Remove vacuum

$-50/+150 \mu\text{m}$  requirement

(a) Glue height (b) Total package height (c) ASIC position (d) ASIC flatness (e) Relative Position for Hybrid and PB

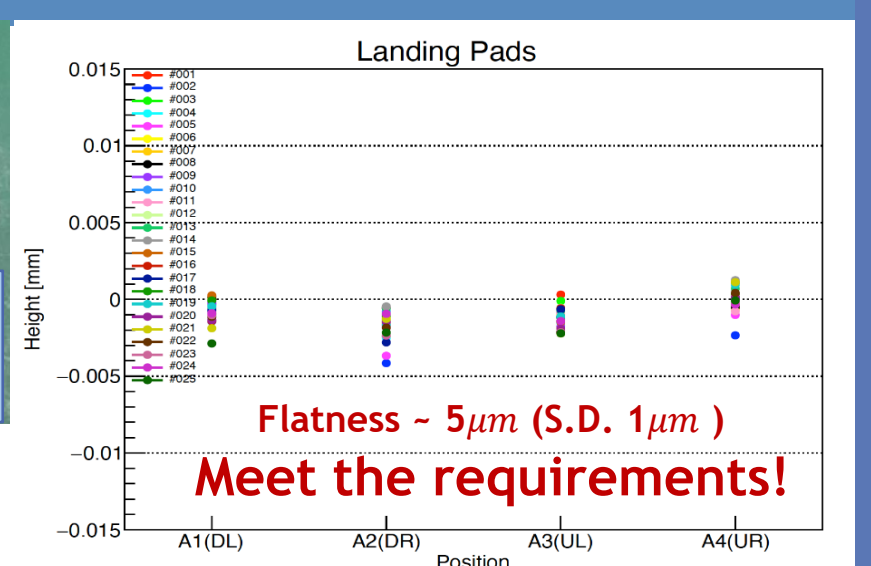
**Conclusion: All of results meet the requirements!**

## Tooling

- ◆ A set of new tools
- ① Hybrid assembly jig
- ② Module test jig
- ③ Module bonding jig
- ④ Module assembly jig
- ⑤ Pickup tool
- ⑥ ASIC tray
- ⑦ Hybrid panel



Partial results



#### ◆ Landing pad flatness check

- Coordinate system: based the point on "DL" to establish a Right-hand coordinate system
- Datum plane: each landing pad takes a point and automatically fits a plane
- Test point selection:  $5 \times 5$  points for each landing pad
- Tolerance requirement:  $0.02 \text{mm}$

## Summary & Outlook

- ◆ This work presents the ITk layout, tooling with modules for ATLAS ITk strip upgrade
- ◆ IHEP has officially passed the requirement for production
- ◆ The inspection of tooling has not found any problems so far
- ◆ The official production of tooling for modules will be promoted

### Ref. Link

- The ATLAS ITk detector system for the Phase-II LHC upgrade <https://doi.org/10.1016/j.nima.2022.167597>
- ATLAS inner tracker strip detector: Technical design report <https://cds.cern.ch/record/2257755>
- Expected tracking and related performance with the updated ATLAS inner tracker layout at the high-luminosity LHC <https://cds.cern.ch/record/2776651>

THANKS FOR YOUR ATTENTION!